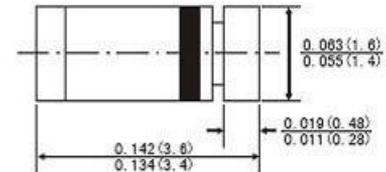




FEATURES

- Metal-on-silicon junction, majority carrier conduction
- High current capability, low forward voltage drop
- Extremely low reverse current I_R
- Ultra speed switching characteristics
- Small temperature coefficient of forward characteristics
- Satisfactory Wave detection efficiency
- For use in RECORDER | TV | RADIO | TELEPHONE as detectors, super high speed switching circuits, small current rectifier

Mini-MELF



MECHANICAL DATA

Dimensions in inches and (millimeters)

- Case: MinMELF glass case (SOD- 80)
- Polarity: color band denotes cathode end
- Weight: Approx. 0.05gram

ABSOLUTE RATINGS(LIMITING VALUES)

Symbols	Parameters		Value		Units
			LL60	LL60P	
V _{RRM}	Repetitive Peak Reverse Voltage		20	30	Volts
I _F	Forward Continuous Current	T _A =25°C	30	50	mA
I _{FSM}	Peak Forward Surge Current(t=1S)		150	400	mA
T _{STG} /T _J	Storage and junction Temperature Range		-65 to +125		°C
T _L	Maximum Lead Temperature for Soldering during 10S at 4mm from Case		230		°C

ELECTRICAL CHARACTERISTICS

Symbols	Parameters	Test Conditions		Value			Units
				Min .	Typ .	Max .	
V _F	Forward Voltage	I _F =1mA	LL60	0.35	0.5	Volts	
			LL60P	0.26	0.5		
		I _F =30mA	LL60	0.70	1.0		
			LL60P	0.70	1.0		
I _R	Reverse Current	V _R =15V	LL60	1.0	5.0	μA	
			LL60P	5.0	10.0		
C _J	Junction Capacitance	V _R =1V f=1MHz	LL60	4.0	pF		
		V _R =10V f=1MHz	LL60P	10.0			
η	Detection Efficiency(See diagram 4)	V _i =3V f=30MHz C _L =10pF R _L =3.8kΩ		60	%		
t _{rr}	Reverse Recovery time	I _F =I _R =1mA I _{TR} =1mA R _C =100Ω		1	ns		
R _{θJA}	Junction Ambient Thermal Resistance	R _{JA}		350	°C/W		